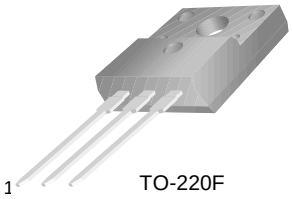
FAIRCHILD
SEMICONDUCTOR®

FJPF5021

High Voltage and High Reliability

- High Speed Switching : t_F = 0.1μs(Typ.)
- Wide SOA



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TO-220F

1.Base 2.Collector 3.Emitter

NPN Silicon Transistor

Absolute Maximum Ratings T_C=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V_{CBO}	Collector-Base Voltage	800	V
V_{CEO}	Collector-Emitter Voltage	500	V
V_{EBO}	Emitter-Base Voltage	7	V
I_C	Collector Current (DC)	5	A
I_{CP}	Collector Current (Pulse)	10	A
I_B	Base Current	2	A
P_C	Collector Dissipation (T_C=25°C)	40	W
T_J	Junction Temperature	150	°C
T_{STG}	Storage Temperature	- 55 ~ 150	°C

Electrical Characteristics T_C=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
BV_{CBO}	Collector-Base Breakdown Voltage	I_C = 1mA, I_E = 0	800			V
BV_{CEO}	Collector-Emitter Sustaining Voltage	I_C = 5mA, I_B = 0	500			V
BV_{EBO}	Emitter-Base Breakdown Voltage	I_E = 1mA, I_C = 0	7			V
V_{CEX} (sus)	Collector-Emitter Sustaining Voltage	I_C = 2.5A, I_{B1} = -I_{B2} = 1A L = 1mH, Clamped	500			V
I_{CBO}	Collector Cut-off Current	V_{CB} = 500V, I_E = 0			10	μA
I_{EBO}	Emitter Cut-off Current	V_{EB} = 5V, I_C = 0			10	μA
h_{FE1} h_{FE2}	DC Current Gain	V_{CE} = 5V, I_C = 0.6A V_{CE} = 5V, I_C = 3A	15 8		50	
V_{CE}(sat)	Collector-Emitter Saturation Voltage	I_C = 3A, I_B = 0.6A			1	V
V_{BE}(sat)	Base-Emitter Saturation Voltage	I_C = 3A, I_B = 0.6A			1.5	V
C_{ob}	Output Capacitance	V_{CB} = 10V, I_E = 0, f = 1MHz		80		pF
f_T	Current Gain Bandwidth Product	V_{CE} = 10V, I_C = 0.6A		15		MHz
t_{ON}	Turn On Time	V_{CC} = 200V I_C = 5I_{B1} = -2.5I_{B2} = 4A R_L = 50Ω			0.5	μs
t_{STG}	Storage Time				3	μs
t_F	Fall Time			0.1	0.3	μs

h_{FE} Classification

Classification	R	O	Y
h_{FE1}	15 ~ 30	20 ~ 40	30 ~ 50

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Typical Characteristics

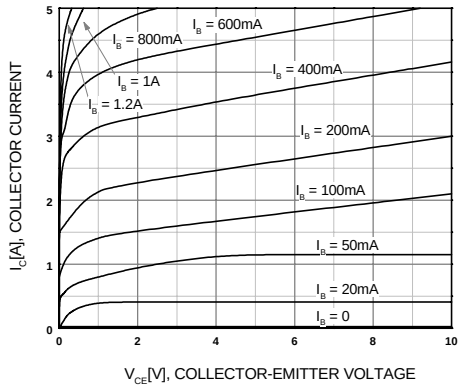

Figure 1. Static Characteristic

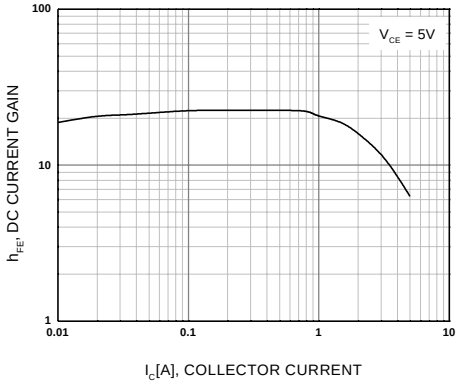

Figure 2. DC current Gain

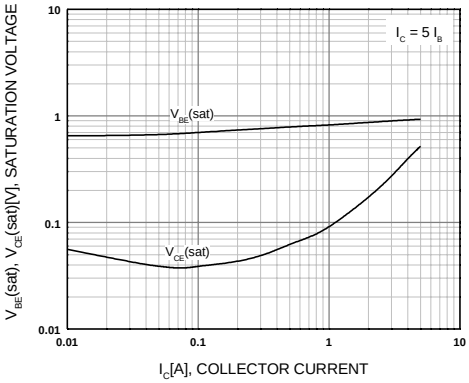

Figure 3. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage

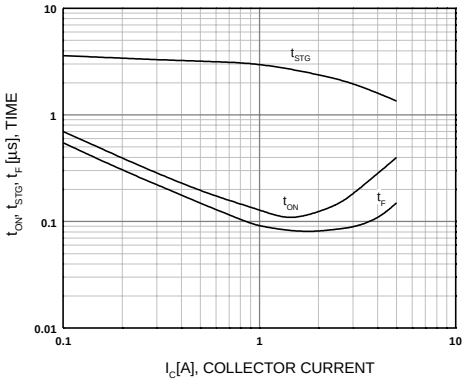

Figure 4. Switching Time

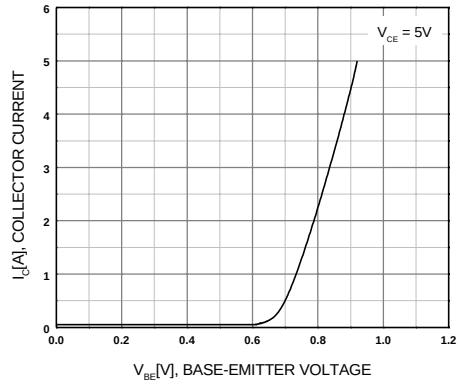

Figure 5. Base-Emitter On Voltage

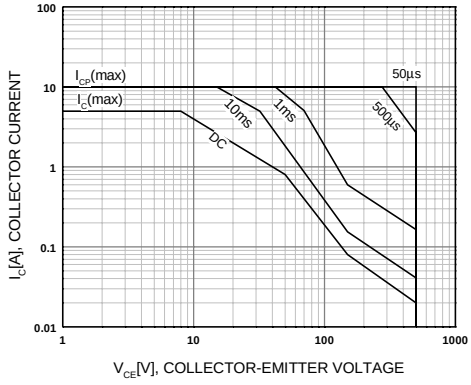

Figure 6. Forward Bias Safe Operating Area

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Typical Characteristics (Continued)

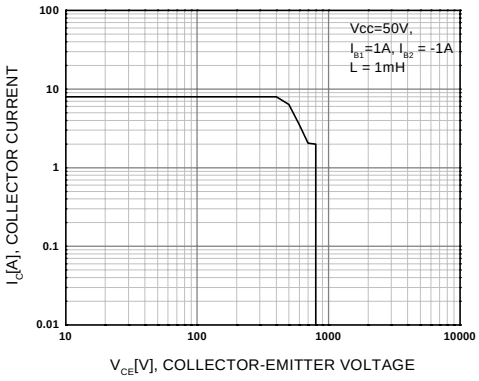

Figure 7. Reverse Bias Safe Operating Area

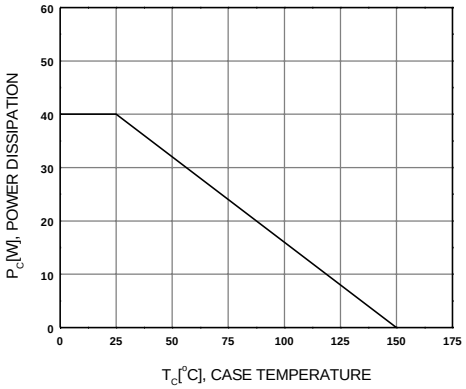

Figure 8. Power Derating

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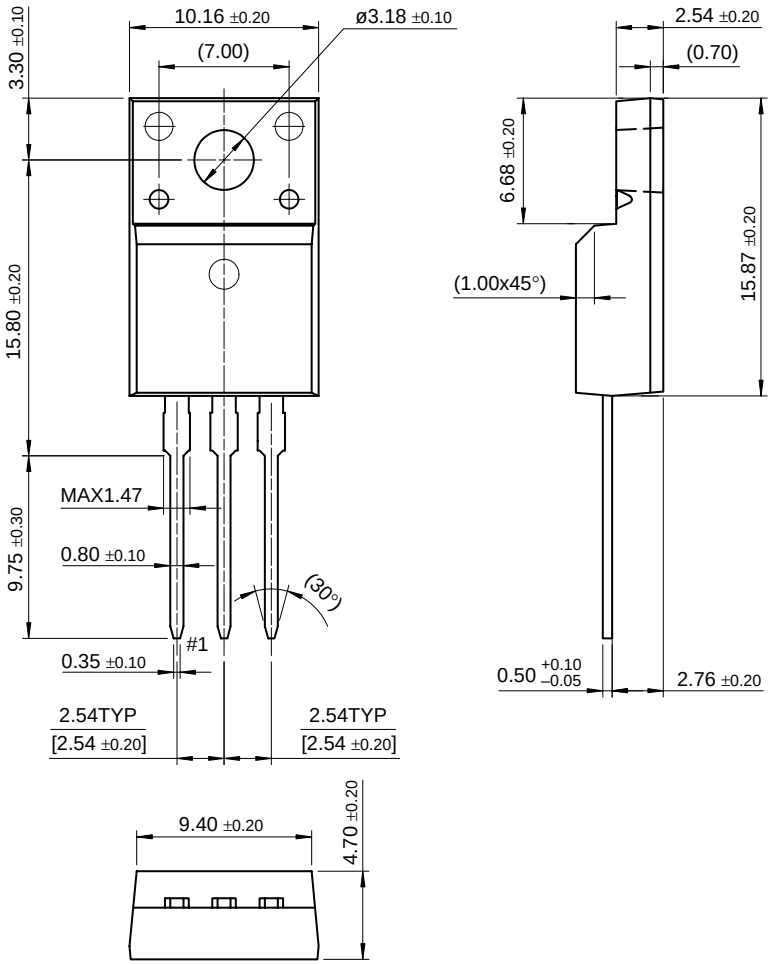
Package Dimensions

TO-220F



Dimensions in Millimeters

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CoolFET™	FASTr™	MicroFET™	PowerTrench®	SuperSOT™-6
CROSSVOLT™	FRFET™	MicroPak™	QFET™	SuperSOT™-8
DOME™	GlobalOptoisolator™	MICROWIRE™	QS™	SyncFET™
EcoSPARK™	GTO™	MSX™	QT Optoelectronics™	TinyLogic®
E^2CMOS™	HiSeC™	MSXPro™	Quiet Series™	TruTranslation™
EnSigna™	I^2C™	OCX™	RapidConfigure™	UHC™
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The Power Franchise™		OPTOLOGIC®	SILENT SWITCHER®	VCX™
Programmable Active Droop™		OPTOPLANAR™	SMART START™	

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